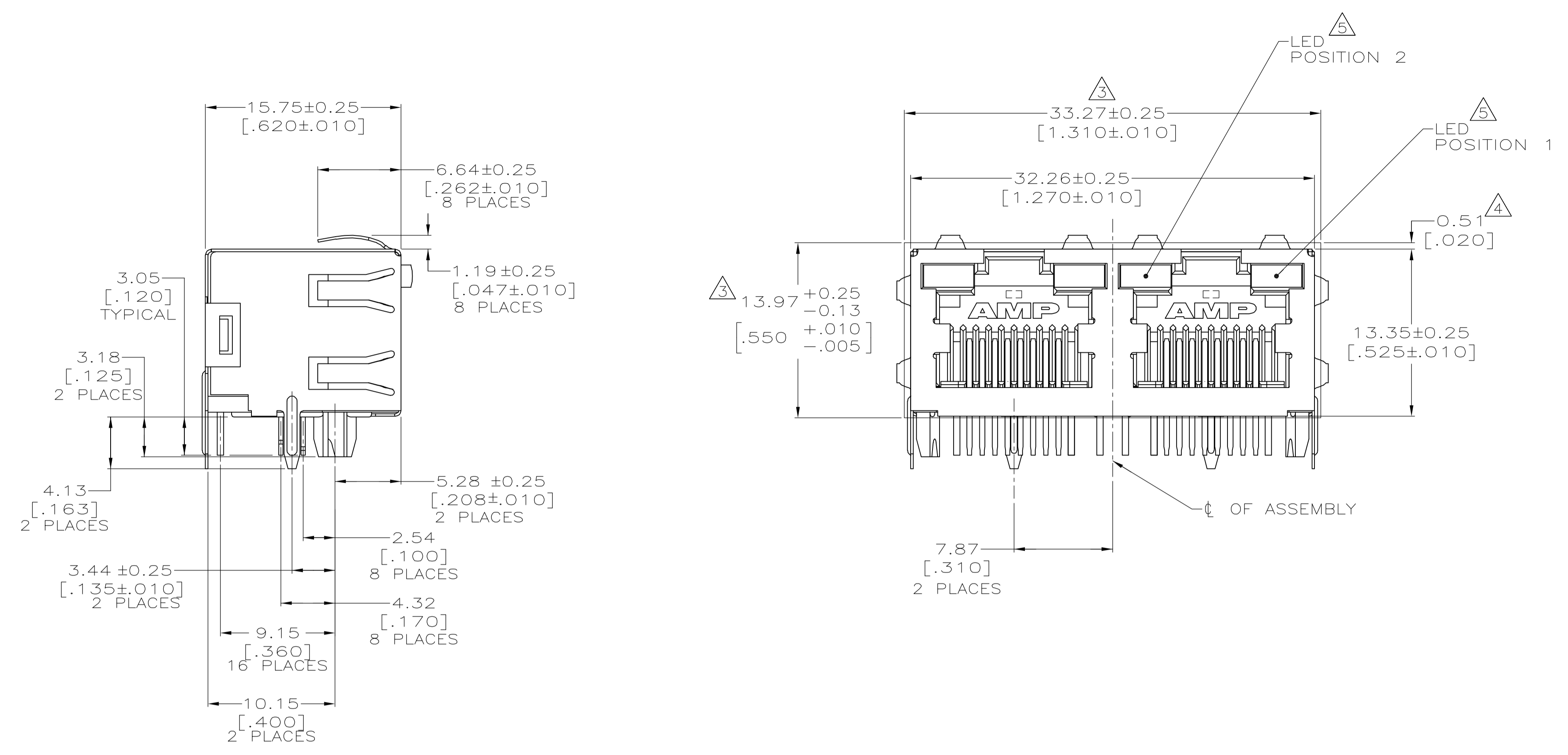
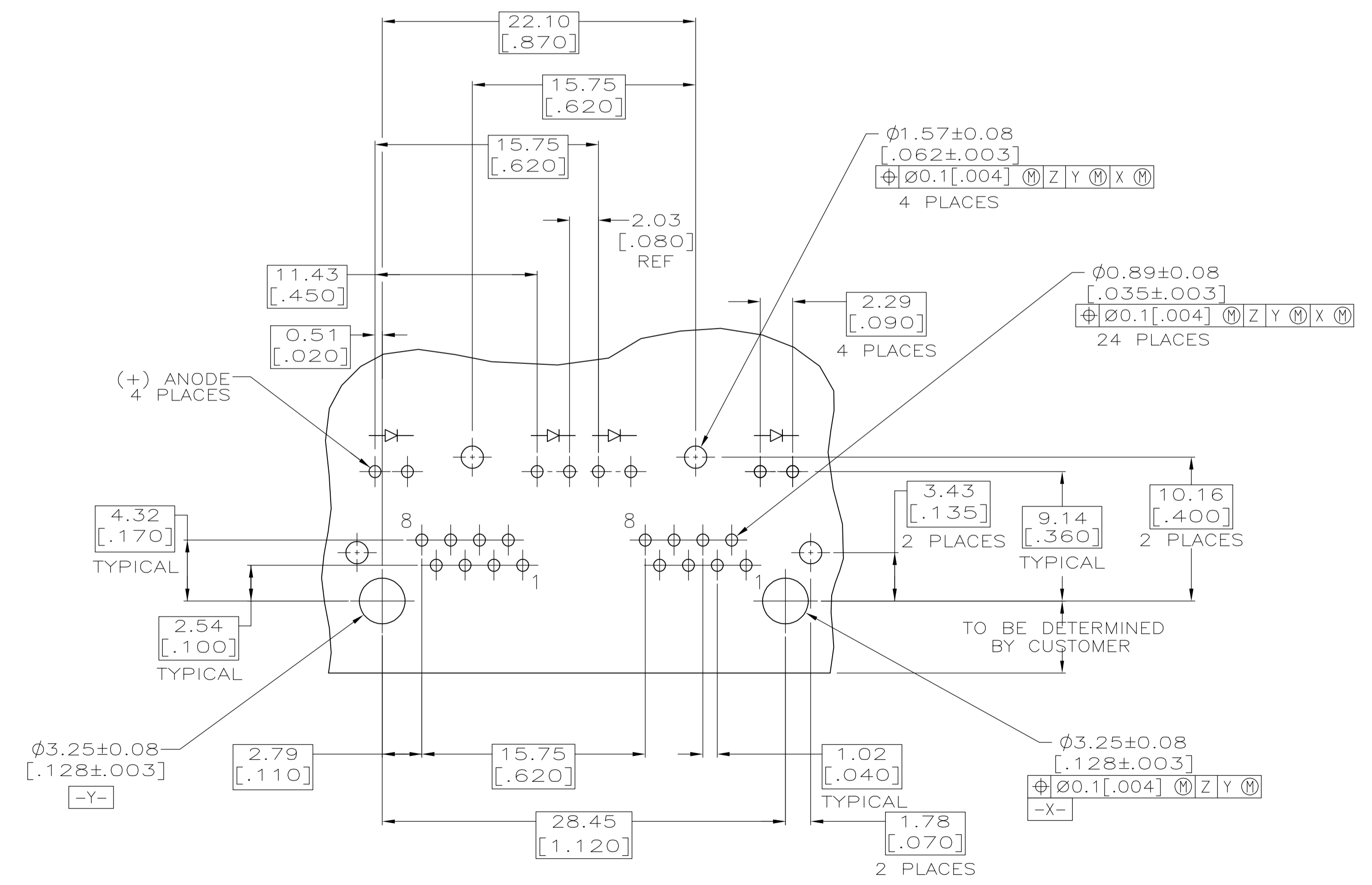


LOC		DIST		REVISIONS			
P	LTR	DESCRIPTION	DATE	OWN	APVD		
A	REV PER EC	OS11-0201-04	16JUN2005	LV	SF		



- △ MATERIAL:
 HOUSING - HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0.
 TERMINALS - 0.36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27µm [.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [.000050] MINIMUM THICK NICKEL.
 SHIELD - 0.196[.0077] THICK COPPER ZINC ALLOY PREPLATED WITH 1.27µm[.000050] MINIMUM SATIN NICKEL WITH 2.03µm[.000080] MINIMUM TIN POST DIPPED ON PCB GROUND TABS.
 LIGHT EMITTING DIODE (LED) - DIFFUSED EPOXY LENS, 0.51 x 0.51[.020 x .020] CARBON STEEL WIREFRAME LEADS PREPLATED WITH 8.89 µm[.0003500] THICK Sn/Cu OVER 2.03 µm[.000080] THICK Ag OVER 1.02µm[.000040] THICK Cu OVER 3.56 µm[.000140] THICK Ni OVER 1.02µm[.000040] Cu UNDERPLATE
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
 - △ SUGGESTED PANEL OPENING DIMENSIONS.
 - △ SUGGESTED CLEARANCE BETWEEN TOP OF CONNECTOR AND TOP PANEL OPENING.
 - △ SEE TABLE FOR COLOR OF LEDS AND NUMBER REQUIRED.
 - THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
 (COMPONENT SIDE)

GREEN	YELLOW	6368460-4
POSITION 2	POSITION 1	PART NUMBER
INDICATOR COLOR FOR EACH HOUSING		

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWG		16JUN2005		Tyco Electronics Corporation	
DIMENSIONS: mm[inches]		L VARELA - D00435		S WESTMAN		Harrisburg, PA 17105-3608	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		S FLICKINGER		NAME		INVERTED MODULAR JACK ASSEMBLY, 1X2, SHIELDED, PANEL GROUND, WITH LEDS	
0 PLC	± -	PRODUCT SPEC		108-1163-4		RESTRICTED TO	
1 PLC	± -	APPLICATION SPEC		114-2154		SIZE CAGE CODE DRAWING NO	
2 PLC	± 0.25[.01]	MATERIAL		A1 00779		SCALE 4:1 SHEET 1 OF 1 REV A	
3 PLC	± 0.13[.005]	FINISH		C=6368460		CUSTOMER DRAWING	
4 PLC	± -						
ANGLES	± -						

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)